

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT2608068

SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>DAE KYUNG AHN</td> <td>10/31/2013</td> </tr> <tr> <td>CHUL-YONG CHO</td> <td>10/27/2013</td> </tr> <tr> <td>SANGMIN HYUN</td> <td>11/01/2013</td> </tr> <tr> <td>EUN VIT CHUNG</td> <td>10/31/2013</td> </tr> </tbody> </table>		Name	Execution Date	DAE KYUNG AHN	10/31/2013	CHUL-YONG CHO	10/27/2013	SANGMIN HYUN	11/01/2013	EUN VIT CHUNG	10/31/2013
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CHUL-YONG CHO	10/27/2013										
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RECEIVING PARTY DATA											
Name:	SAMSUNG ELECTRONICS CO., LTD.										
Street Address:	129, SAMSUNG-RO, YEONGTONG-GU, SUWON-SI, GYEONGGI-DO 443-742										
City:	SUWON-SI										
State/Country:	KOREA, REPUBLIC OF										
PROPERTY NUMBERS Total: 1											
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>29472089</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	29472089						
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Application Number:	29472089										
CORRESPONDENCE DATA											
Fax Number:	(202)315-3758										
Phone:	202-429-0020										
Email:	pto@nsiplaw.com										
<i>Correspondence will be sent via US Mail when the email attempt is unsuccessful.</i>											
Correspondent Name:	NSIP LAW										
Address Line 1:	P.O. BOX 65745										
Address Line 4:	WASHINGTON, DISTRICT OF COLUMBIA 20035										
ATTORNEY DOCKET NUMBER:	D91058.0043										
NAME OF SUBMITTER:	CHARLES Y. PARK										
Signature:	/Charles Y. Park/										
Date:	11/08/2013										
Total Attachments: 2 source=NewDesApp_D910580043_Assignment_AsFiled#page1.tif source=NewDesApp_D910580043_Assignment_AsFiled#page2.tif											

OP \$40.00 29472089

COMBINED DECLARATION AND ASSIGNMENT UNDER 37 CFR 1.63(e)**DECLARATION**

As a below-named inventor, I hereby declare that this declaration is directed to the application attached hereto, or to United States Application Number or PCT International Application Number _____ filed on _____ (if applicable), entitled:

TABLET COMPUTER

The above-identified application was made or authorized to be made by me.

I believe I am the original inventor or an original joint inventor of a claimed invention in the above-identified application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 USC 1001 by fine or imprisonment of not more than five (5) years, or both.

I have reviewed and understand the contents of the above-identified application, including the claims.

I am aware of the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in 37 CFR 1.56, including for continuation-in-part applications, material information that became available between the filing date of the prior application and the national or PCT international filing date of the continuation-in-part application.

ASSIGNMENT

For valuable consideration, I, as a below-named assignor, hereby assign to:

Samsung Electronics, Co., Ltd
129, Samsung-ro, Yeongtong-gu
Suwon-si, Gyeonggi-do, 443-742
Republic of Korea

and its successors and assigns (collectively hereinafter called "the Assignee"), the entire right, title, and interest throughout the world in the inventions and improvements that are the subject of the application identified in the above declaration, which is United States Application Number or PCT International Application Number 29/472,089 filed on November 8, 2013

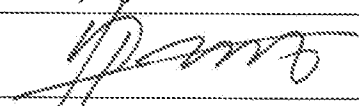
I authorize and request the attorneys appointed in the above-identified application to hereafter complete this Assignment by inserting above the application number and the filing date of the above-identified application when known, and to correct any typographical errors that may be discovered in this Assignment.

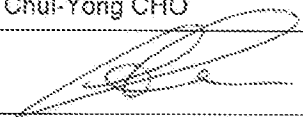
This Assignment includes the above-identified application, any and all United States and foreign patents, utility models, and design registrations granted for any of the inventions and improvements that are the subject of the above-identified application, and the right to claim priority based on the filing date of the above-identified application under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all other treaties of like purposes; and I authorize the Assignee to apply in all countries in my name or in its own name for patents, utility models, design registrations, like rights of exclusion, and inventors' certificates for any of the inventions and improvements that are the subject of the above-identified application; and I agree for myself and my heirs, legal representatives, and assigns without further

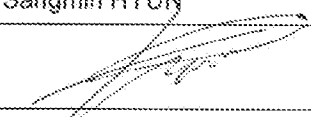
COMBINED DECLARATION AND ASSIGNMENT UNDER 37 CFR 1.63(e)

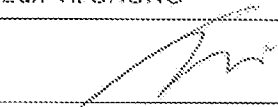
compensation to perform such lawful acts and to sign such further applications, Assignments, preliminary statements, and other lawful documents as the Assignee may reasonably request to effectuate fully this Assignment.

In witness whereof, I, as a below-named inventor and assignor, intending to be legally bound, have hereunto affixed my signature on the date indicated below next to my signature.

Inventor's Legal Name	Dae Kyung AHN		
Inventor's Signature		Date	2013.10.31
Residence (City, Country)	Namyangjusi, Republic of Korea		
Mailing Address	1408-1202 Kumho Apt., Pyungnae-dong, Namyangjusi, Kyungki-do, Republic of Korea		

Inventor's Legal Name	Chul-Yong CHO		
Inventor's Signature		Date	2013.10.29
Residence (City, Country)	Seoul, Republic of Korea		
Mailing Address	102-407 Jugong Apt. Guro-1dong Guro-gu Seoul, Republic of Korea		

Inventor's Legal Name	Sangmin HYUN		
Inventor's Signature		Date	2013.11.1
Residence (City, Country)	Seoul, Republic of Korea		
Mailing Address	201-603 Daewoo Memberscounty, 809-26 Bangbae-4dong, Seocho-gu, Seoul, Republic of Korea		

Inventor's Legal Name	Eun Vii CHUNG		
Inventor's Signature		Date	2013.10.27
Residence (City, Country)	Seoul, Republic of Korea		
Mailing Address	521-1309, Chungsil 5 danji Apt., Jamsil 3-dong, Songpa-gu, Seoul, Republic of Korea		